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3.3V CMOS 16-BIT EDGE TRIGGERED D-TYPE FLIP-FLOP WITH 3-STATE OUTPUTS, 5 VOLT TOLERANT I/O, BUS-HOLD

IDT74LVCH162374A

FEATURES:

- Typical tSK(o) (Output Skew) < 250ps
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- Vcc = 3.3V ± 0.3V, Normal Range
- Vcc = 2.7V to 3.6V, Extended Range
- CMOS power levels (0.4µ W typ. static)
- · All inputs, outputs, and I/O are 5V tolerant
- Available in TSSOP package

DRIVE FEATURES:

- Balanced Output Drivers: ±12mA
- · Low switching noise

APPLICATIONS:

- 5V and 3.3V mixed voltage systems
- · Data communication and telecommunication systems

FUNCTIONAL BLOCK DIAGRAM

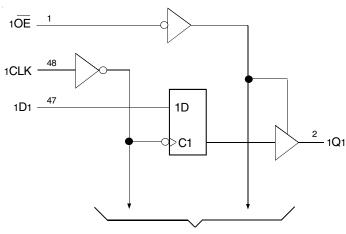
DESCRIPTION:

The LVCH162374A 16-bit edge-triggered D-type flip-flop is built using advanced dual metal CMOS technology. This high-speed, low-power register is ideal for use as a buffer register for data synchronization and storage. The output enable (\overline{OE}) and clock (CLK) controls are organized to operate each device as two 8-bit registers or one 16-bit register with common clock. Flow-through organization of signal pins simplifies layout. All inputs are designed with hysteresis for improved noise margin.

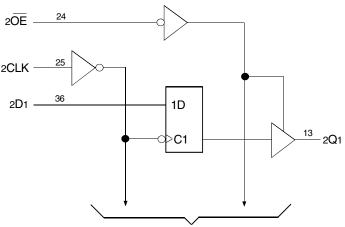
All pins of the LVCH162374A can be driven from either 3.3V or 5V devices. This feature allows the use of this device as a translator in a mixed 3.3V/5V supply system.

The LVCH162374A has series resistors in the device output structure which will significantly reduce line noise when used with light loads. This driver has been developed to drive ± 12 mA at the designated thresholds.

The LVCH162374A has "bus-hold" which retains the inputs' last state whenever the input goes to a high impedance. This prevents floating inputs and eliminates the need for pull-up/down resistors.



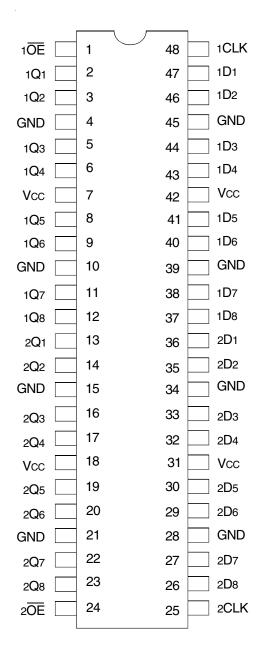
TO SEVEN OTHER CHANNELS



TO SEVEN OTHER CHANNELS

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PIN CONFIGURATION



TSSOP TOP VIEW

INDUSTRIAL TEMPERATURE RANGE

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
VTERM	Terminal Voltage with Respect to GND	–0.5 to +6.5	V
Tstg	Storage Temperature	–65 to +150	°C
Ιουτ	DC Output Current	–50 to +50	mA
Ік Іок	Continuous Clamp Current, Vı < 0 or Vo < 0	-50	mA
lcc Iss	Continuous Current through each Vcc or GND	±100	mA

NOTE:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

CAPACITANCE (TA = +25°C, F = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Тур.	Max.	Unit
CIN	Input Capacitance	VIN = 0V	4.5	6	pF
Соит	Output Capacitance	Vout = 0V	6.5	8	pF
CI/O	I/O Port Capacitance	VIN = 0V	6.5	8	pF

NOTE:

1. As applicable to the device type.

PIN DESCRIPTION

Pin Names	Description	
xDx	Data Inputs ⁽¹⁾	
xCLK	Clock Inputs	
xQx	3-State Outputs	
xŌĒ	3-State Output Enable Inputs (Active LOW)	

NOTE:

1. These pins have "Bus-Hold". All other pins are standard inputs, outputs, or I/Os.

FUNCTION TABLE (EACH FLIP-FLOP)⁽¹⁾

	Outputs		
xOE	xCLK	xDx	xQx
L	\uparrow	Н	Н
L	\uparrow	L	L
L	H or L	Х	Q ⁽²⁾
Н	Х	Х	Z

NOTES:

1. H = HIGH Voltage Level

X = Don't Care

L = LOW Voltage Level

Z = High-Impedance

2. Output level before the indicated steady-state input conditions were established.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified: Operating Condition: TA = -40 °C to +85 °C

Symbol	Parameter	Test 0	Conditions	Min.	Typ. ⁽¹⁾	Max.	Unit
VIH	Input HIGH Voltage Level	Vcc = 2.3V to 2.7V		1.7	-	_	V
		Vcc = 2.7V to 3.6V		2	_	_	
VIL	Input LOW Voltage Level	Vcc = 2.3V to 2.7V		_	_	0.7	V
		Vcc = 2.7V to 3.6V		_	-	0.8	
Ін	Input Leakage Current	Vcc = 3.6V	VI = 0 to 5.5V	_	-	±5	μA
lı∟							
Іоzн	High Impedance Output Current	Vcc = 3.6V	Vo = 0 to 5.5V	-	-	±10	μA
lozl	(3-State Output pins)						
IOFF	Input/Output Power Off Leakage	Vcc = 0V, VIN or Vo \leq 5.5V		-	-	±50	μA
Vik	Clamp Diode Voltage	Vcc = 2.3V, IIN = -18mA		-	-0.7	-1.2	V
Vн	Input Hysteresis	Vcc = 3.3V		_	100	_	mV
ICCL	Quiescent Power Supply Current	Vcc = 3.6V	VIN = GND or VCC	-	-	10	μA
Іссн Іссz			$3.6 \le VIN \le 5.5V^{(2)}$			10	
Δ lcc	Quiescent Power Supply Current Variation	One input at Vcc - 0.6V, othe	er inputs at Vcc or GND	-	-	500	μA

NOTES:

1. Typical values are at Vcc = 3.3V, +25°C ambient.

2. This applies in the disabled state only.

BUS-HOLD CHARACTERISTICS

Symbol	Parameter ⁽¹⁾	Test Conditions		Min.	Typ. ⁽²⁾	Max.	Unit
Івнн	Bus-Hold Input Sustain Current	Vcc = 3V	VI = 2V	-75	—	_	μA
IBHL			VI = 0.8V	75	—	—	
Івнн	Bus-Hold Input Sustain Current	Vcc = 2.3V	VI = 1.7V	_	—	_	μA
IBHL			VI = 0.7V	_	—	-	
Івнно	Bus-Hold Input Overdrive Current	Vcc = 3.6V	VI = 0 to 3.6V	_	_	±500	μA
Ibhlo							

NOTES:

1. Pins with Bus-Hold are identified in the pin description.

2. Typical values are at Vcc = 3.3V, +25°C ambient.

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Con	ditions ⁽¹⁾	Min.	Max.	Unit
Vон	Output HIGH Voltage	Vcc = 2.3V to 3.6V	Іон = - 0.1mA	Vcc-0.2	_	V
		Vcc = 2.3V	IOH = - 4mA	1.9	_	
			Iон = - 6mA	1.7	_	
		Vcc = 2.7V	Iон = - 4mA	2.2	_	
			Iон = - 8mA	2	_	
		Vcc = 3V	Iон = – 6mA	2.4	-	
			Іон = – 12mA	2	_	
Vol	Output LOW Voltage	Vcc = 2.3V to 3.6V	IOL = 0.1mA	_	0.2	V
		Vcc = 2.3V	IOL = 4mA	—	0.4	
			IOL = 6mA	_	0.55	
		Vcc = 2.7V	IOL = 4mA	—	0.4	
			IOL = 8mA	_	0.6	
		Vcc = 3V	IOL = 6mA	_	0.55	
			IOL = 12mA	_	0.8	

NOTE:

1. VIH and VIL must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate Vcc range. TA = − 40°C to + 85°C.

OPERATING CHARACTERISTICS, Vcc = 3.3V ± 0.3V, TA = 25°C

Symbol	Parameter	Test Conditions	Typical	Unit
Cpd	Power Dissipation Capacitance per Flip-Flop Outputs enabled	CL = 0pF, f = 10Mhz	—	pF
Cpd	Power Dissipation Capacitance per Flip-Flop Outputs disabled		—	

SWITCHING CHARACTERISTICS⁽¹⁾

		Vcc	= 2.7V	Vcc = 3.3	V ± 0.3V	
Symbol	Parameter	Min.	Max.	Min.	Max.	Unit
t PLH	Propagation Delay	2	6.5	2	6.2	ns
t PHL	xCLK to xQx					
t PZH	OutputEnableTime	1.5	6.3	1.5	6.1	ns
tPZL	xOE to xQx					
t PHZ	OutputDisableTime	1.5	6.2	1.5	6	ns
tPLZ	xOE to xQx					
ts∪	Set-up Time HIGH or LOW, xDx before xCLK	2.5	—	2.5	—	ns
tH	Hold Time HIGH or LOW, xDx after xCLK	1.5	—	1.5	—	ns
tw	xCLK Pulse Width HIGH or LOW	3	_	3	_	ns
tsk(o)	Output Skew ⁽²⁾	—	_	_	500	ps

NOTES:

1. See TEST CIRCUITS AND WAVEFORMS. TA = -40° C to + 85°C.

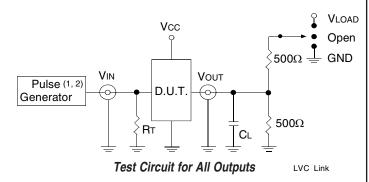
2. Skew between any two outputs of the same package and switching in the same direction.

IDT74LVCH162374A 3.3VCMOS16-BITEDGE-TRIGGEREDD-TYPEFLIP-FLOP

INDUSTRIAL TEMPERATURE RANGE

TEST CIRCUITS AND WAVEFORMS TEST CONDITIONS

Symbol	Vcc ⁽¹⁾ =3.3V±0.3V	Vcc ⁽¹⁾ =2.7V	Vcc ⁽²⁾ =2.5V±0.2V	Unit
VLOAD	6	6	2 x Vcc	V
Vih	2.7	2.7	Vcc	V
Vτ	1.5	1.5	Vcc/2	V
Vlz	300	300	150	mV
VHZ	300	300	150	mV
CL	50	50	30	pF



DEFINITIONS:

CL = Load capacitance: includes jig and probe capacitance.

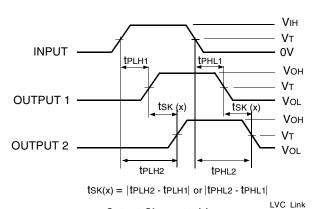
RT = Termination resistance: should be equal to ZOUT of the Pulse Generator.

NOTES:

1. Pulse Generator for All Pulses: Rate \leq 10MHz; tF \leq 2.5ns; tR \leq 2.5ns. 2. Pulse Generator for All Pulses: Rate \leq 10MHz; tF \leq 2ns; tR \leq 2ns.

SWITCH POSITION

Test	Switch
Open Drain Disable Low Enable Low	Vload
Disable High Enable High	GND
All Other Tests	Open

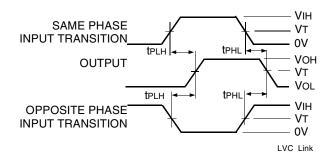


Output Skew - tsk(x)

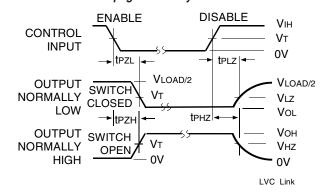
NOTES:

1. For tsk(o) OUTPUT1 and OUTPUT2 are any two outputs.

2. For tsk(b) OUTPUT1 and OUTPUT2 are in the same bank.



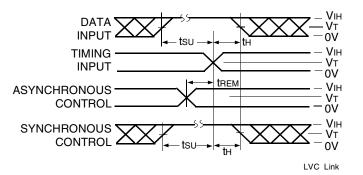
Propagation Delay

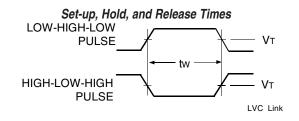


Enable and Disable Times

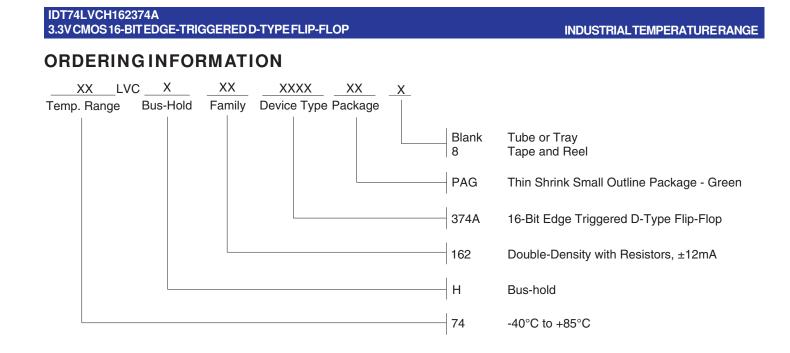
NOTE:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.





Pulse Width



Datasheet Document History

01/29/2015 Pg. 1,2,6 Updated the ordering information by removing the "IDT" notation, non RoHS part, SSOP package and by adding Tape and Reel information.



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